



ORDERING INFORMATION

Ordering Number		Deekege	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Facking	
MMBTA55L-AE3-R MMBTA55G-AE3-R		SOT-23	Е	В	С	Tape Reel	
MMBTA55L-AL3-R	MMBTA55G-AL3-R	SOT-323	Е	В	С	Tape Reel	
Note: Pin assignment: E: EMITTER, C: COLLECTOR, B: BASE							

MMBTA55L-AE3-R		
	(1)Packing Type	(1) R: Tape Reel
	(2)Package Type	(2) AE3: SOT-23, AL3: SOT-323
	(3)Lead Free	(3) L: Lead Free, G: Halogen Free

MARKING



■ ABSOLUTE MAXIMUM RATING (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Collector-base voltage		V _{CBO}	60	V
Collector-emitter voltage		V _{CEO}	60	V
Emitter-base voltage		V _{EBO}	4	V
Collector current - Continuous		Ι _C	500	mA
Total device dissipation	T _A =25°C	- P _D	350	mW
	Derate above 25°C		2.8	mW/°C
Junction Temperature		ΤJ	125	°C
Storage Temperature		T _{STG}	-40 ~ +150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

THERMAL DATA

PARAMETER	PARAMETER SYMBOL RATINGS		UNIT		
Junction to Ambient	θ _{JA}	357	°C/W		

Note: $R_{\theta JA}$ is measured with the device soldered into a typical printed circuit board.

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	МАХ	UNI T
OFF CHARACTERISTICS						
Collector-emitter breakdown voltage (note 1)	V _{(BR)CEO}	I _C =1.0mA, I _B =0	60			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =100μA, Ic=0	4			V
Collector cutoff current	I _{CES}	V _{CE} =60V, I _B =0			0.1	μA
Collector cutoff current	I _{CBO}	V _{CB} =60V, I _E =0			0.1	μA
ON CHARACTERISTICS						
DC surrent soin	h _{FE}	I _C =10mA, V _{CE} =1V	100			
DC current gain		I _C =100mA, V _{CE} =1V	100			
Collector-emitter saturation voltage	V _{CE(SAT)}	I _C =100mA, I _B =10mA			0.25	V
Base-emitter on voltage	V _{BE(ON)}	I _C =100mA, V _{CE} =1V			1.2	V
SMALL-SIGNAL CHARACTERISTICS						
Current gain bandwidth product (note 2)	f _T	I _C =100mA, V _{CE} =1V, f=100MHz	50			MHz

Note 1. Pulse test: PW<=300µs, Duty Cycle<=2%

2. f_{T} is defined as the frequency at which Ihfel extrapolates to unity.



SWITCHING TIME TEST CIRCUIT



Figure 1. (Note: Total shunt capacitance of test jig and connectors for PNP test circuits, reverse all voltage polarities.)

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